

# APPLICATION NOTE

Product Name	M500
Version	802.11b/g/n, BT 2.1+EDR, FM Rx, GPS SiP 4-in-1 Module A
Doc No	902-03201
Date	Jan. 04 <sup>th</sup> , 2013

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## Document History

Date	Revise Contents	Revise by	Version
Sep. 27 <sup>th</sup> , 2012		Kenny	1.0
Sep. 28 <sup>th</sup> , 2012	Modify Application Circuit	Kenny	1.1
Jan. 04 <sup>th</sup> , 2013	Modify Application Circuit & add Recommended Footprint	Kenny	A

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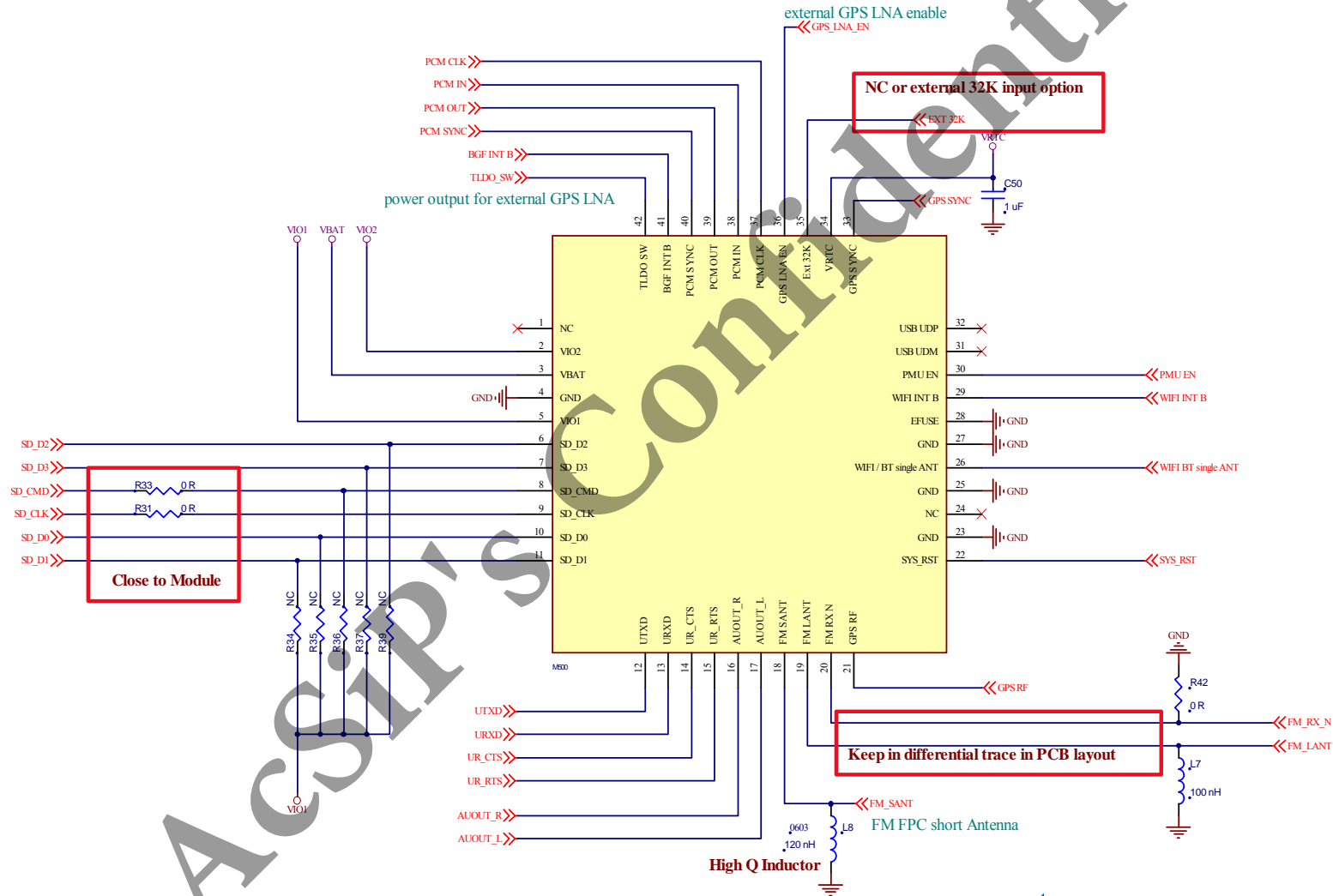
# INDEX

<b>1. Application Circuit .....</b>	<b>4</b>
1-1. M500 reference design.....	4
1-2. External LNA for GPS .....	5
1-3. WiFi / BT & GPS single antenna .....	5
1-4. WiFi / BT & GPS dual antenna.....	6
1-5. FM audio jack / antenna.....	7
1-6. Application Note.....	8
<b>2. Layout Guide.....</b>	<b>8</b>
2-1. Power Line Management .....	8
2-2. 32kHz Clock Management (optional).....	8
2-3. SDIO Bus .....	8
2-4. Ground Management .....	9
2-5. RF Trace Management.....	9
2-6. Recommended Footprint.....	9
<b>3. The Other Information.....</b>	<b>9</b>

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# 1. Application Circuit

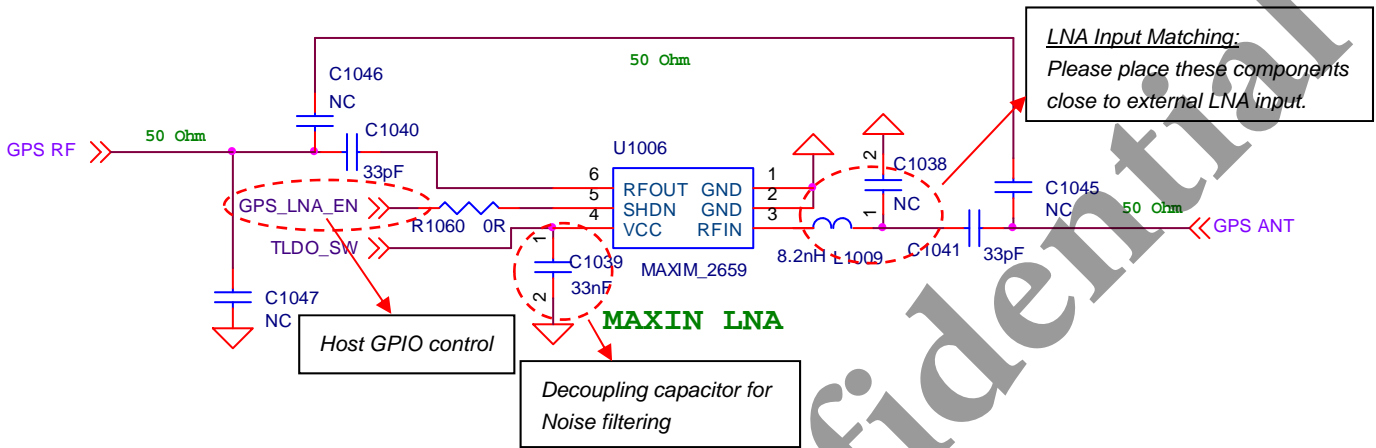
## 1-1. M500 reference design



Product Name	M500 802.11b/g/n, BT 2.1+EDR, FM Rx, GPS SiP 4-in-1 Module
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Page	4 of 9

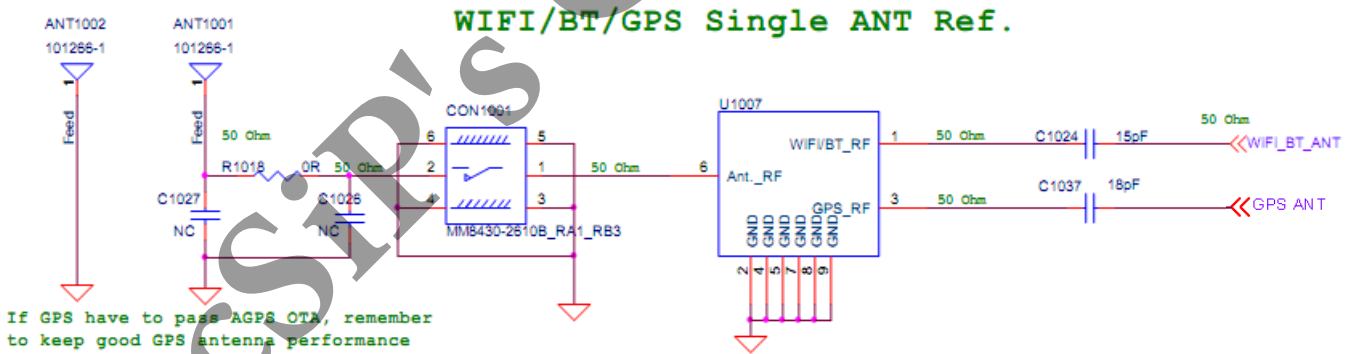
### 1-2. External LNA for GPS

- Use **host GPIO (recommended)** or GPS\_LNA\_EN to control GPS external LNA enable pin.
- Place decoupling capacitor to close to external LNA power pin.
- Place matching components close to external LNA input.



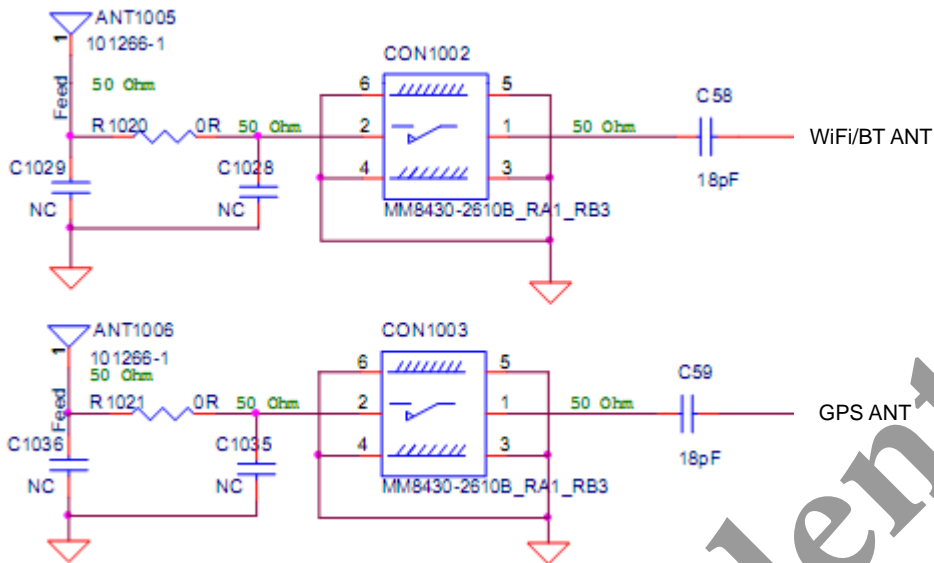
**(Optional) external LNA for better GPS performance**

### 1-3. WiFi / BT & GPS single antenna



**(Optional) reserve L=39nH at C1026 for ESD protection**

1-4. WiFi / BT & GPS dual antenna

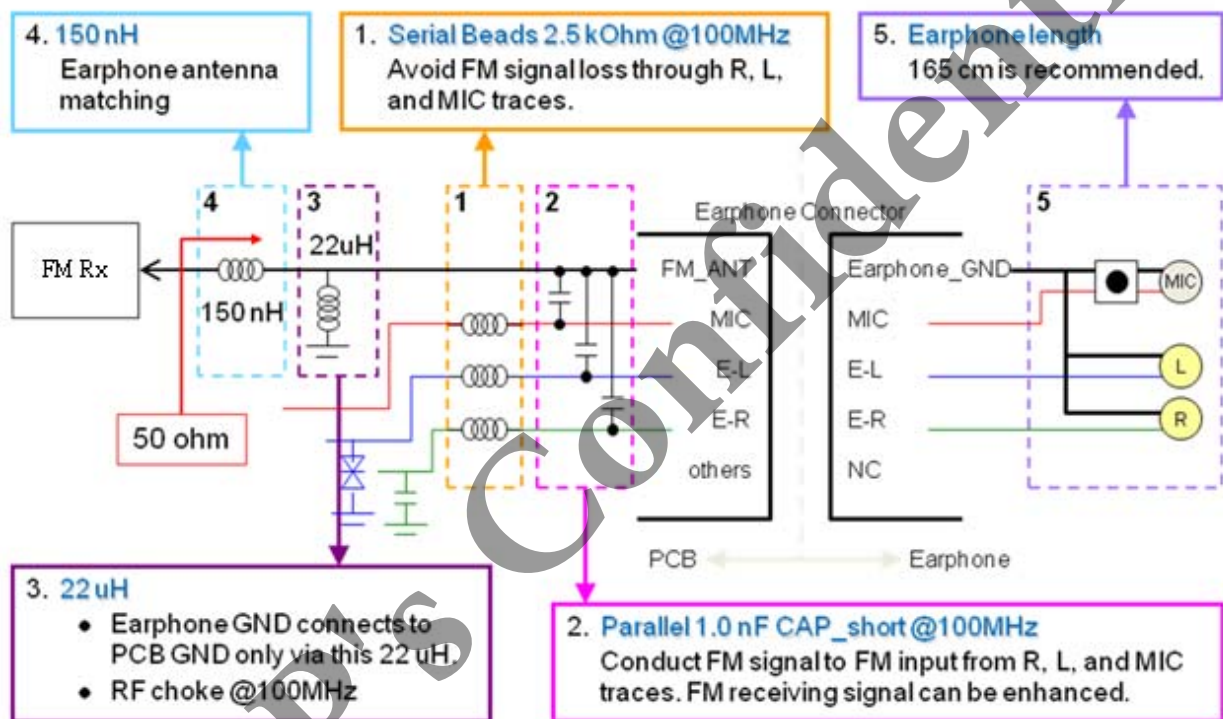


**(Optional) reserve L=39nH at C1028 / C1035 for ESD protection**

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### 1-5. FM audio jack / antenna

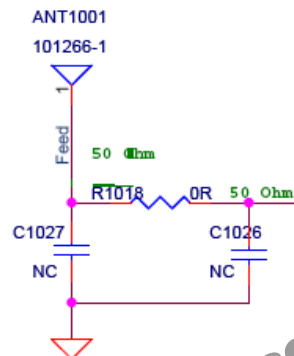
- Add a LPF(chip out series 27nH, than parallel 10pF) on FM long Antenna trace, for WLAN/BT out band blocking de-sense.
- Keep FM Antenna(audio jack/ usb / FPC) and RF traces away from power source and other Antenna like WLAN/BT/GSM Antenna, to avoid de-sense.
- RF Traces should be far away and well- grounded from VBAT / VDDK and any other VDD traces.
- VFM trace should be well ground shielding.



## 1-6. Application Note

The M500 module supports SDIO interface for WiFi, UART for Bluetooth, FM, GPS.

- $\pi$ -network is reserved for antenna matching. The  $\pi$ -network's value in the application circuit can be configurable.



## 2. Layout Guide

### 2-1. Power Line Management

- The power lines should be directly connected with regulator outputs, and add 1uF bypass capacitors close to module on each power line.
- Never let power trace cross the other one including signal trace.

### 2-2. 32kHz Clock Management (optional)

- The 32KHz signal trace couldn't be mixed with any power line, and avoid any signal trace close to 32KHz signal trace.

### 2-3. SDIO Bus

- Please reserve damping resistors on SDIO\_CMD and SDIO\_CLK and place them close to module for optimizing SDIO performance.
- Make SDIO\_CLK, CMD and Data in a layout group.
- SDIO\_CLK is a high speed signal and it must be shielded by GND plan for reducing noise. And don't mix them with other trace.



## 2-4. Ground Management

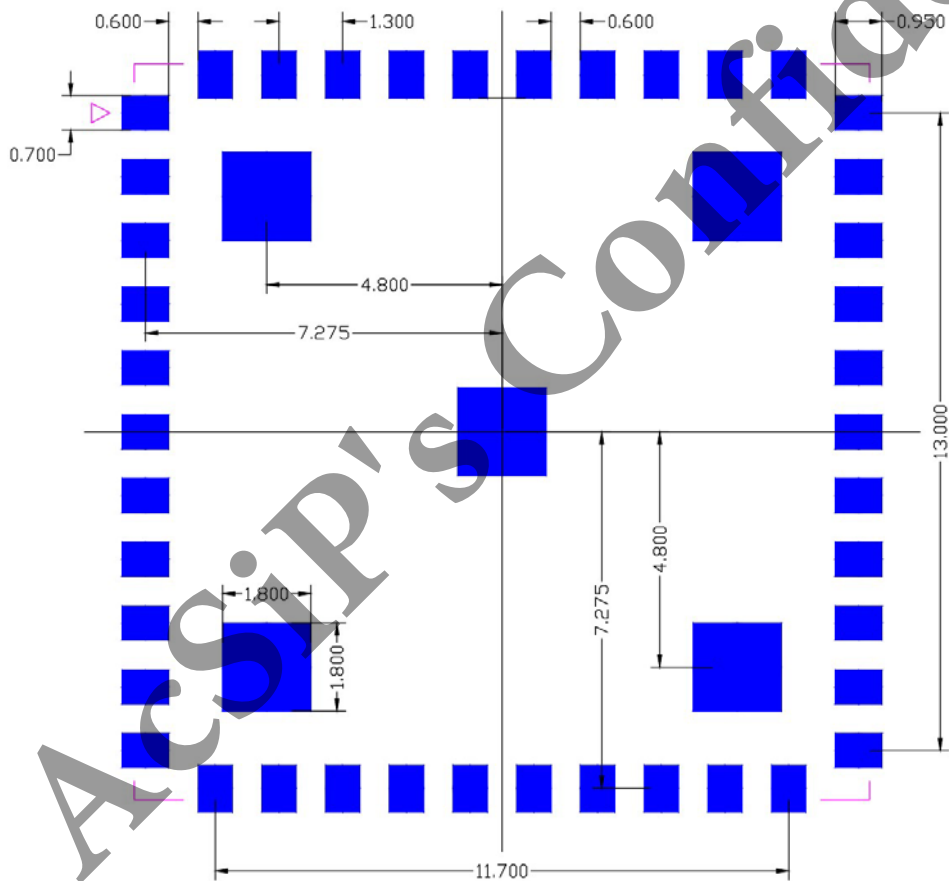
- Please ensure the regional first layer used to mount module is complete to the ground.
- The ground plane on both sides of RF trace needs to add via holes and. We recommend the distance between adding via holes less than  $1/8\lambda$ .

## 2-5. RF Trace Management

- CPWG-type traces used for RF function are recommended, which having better EMC and RF capability.

## 2-6. Recommended Footprint

(TOP VIEW)



UNIT: mm

## 3. The Other Information

- Do not put any signal line or power line on system PCB top layer under M500 module.
- Discuss with AcSiPs' engineer after schematic and layout finished.